

SN54ALS15A, SN74ALS15A TRIPLE 3-INPUT POSITIVE-AND GATES WITH OPEN-COLLECTOR OUTPUTS

SDAS016A – MARCH 1984 – REVISED MAY 1986

- Package Options Include Plastic Small Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs
- Dependable Texas Instruments Quality and Reliability

description

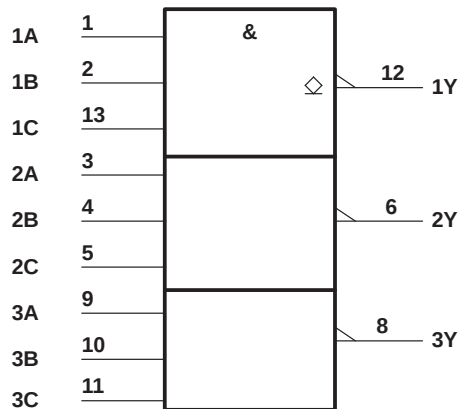
These devices contain three independent 3-input AND gates with open-collector outputs. These gates perform the Boolean functions $Y = A \cdot B \cdot C$ or $Y = \overline{A} + \overline{B} + \overline{C}$ in positive logic. The open-collector outputs require pullup resistors to perform correctly. They may be connected to other open-collector outputs to implement active-low wired-OR or active-high wired-AND functions. Open-collector devices are often used to generate higher V_{OH} levels.

The SN54ALS15A is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ALS15A is characterized for operation from 0°C to 70°C .

FUNCTION TABLE
(each gate)

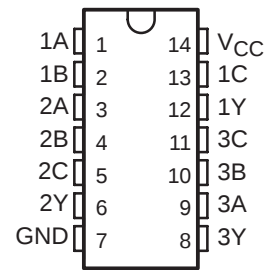
INPUTS			OUTPUT
A	B	C	Y
H	H	H	H
L	X	X	L
X	L	X	L
X	X	L	L

logic symbol†

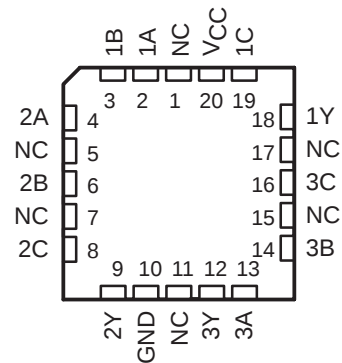


† This symbol is in accordance with ANS/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, and N packages.

SN54ALS15A . . . J PACKAGE
SN74ALS15 . . . D OR N PACKAGE
(TOP VIEW)

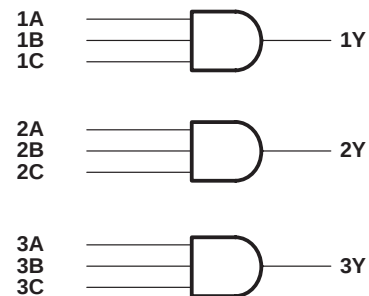


SN54ALS15A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

logic diagram (positive logic)



SN54ALS15A, SN74ALS15A

TRIPLE 3-INPUT POSITIVE-AND GATES

WITH OPEN-COLLECTOR OUTPUTSWITH OPEN-COLLECTOR OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC}	7 V
Input voltage	7 V
Off-state output voltage	7 V
Operating free-air temperature range: SN54ALS15A	– 55°C to 125°C
SN74ALS15A	0°C to 70°C
Storage temperature range	– 65°C to 150°C

recommended operating conditions

		SN54ALS15A			SN74ALS15A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
V_{OH}	High-level output voltage			5.5			5.5	V
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	– 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54ALS15A			SN74ALS15A			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}	$V_{CC} = 4.5$ V,	$I_I = -18$ mA			– 1.5			– 1.5	V
V_{OL}	$V_{CC} = 4.5$ V,	$I_{OL} = 4$ mA		0.25	0.4		0.25	0.4	V
	$V_{CC} = 4.5$ V,	$I_{OL} = 8$ mA					0.35	0.5	
I_{OH}	$V_{CC} = 4.5$ V,	$V_{OH} = 5.5$ mA			0.1			0.1	mA
I_I	$V_{CC} = 5.5$ V,	$V_I = 7$ V			0.1			0.1	mA
I_{IH}	$V_{CC} = 5.5$ V,	$V_I = 2.7$ V			20			20	μA
I_{IL}	$V_{CC} = 5.5$ V,	$V_I = 0.4$ V			– 0.1			– 0.1	mA
I_{CCH}	$V_{CC} = 5.5$ V,	$V_I = 4.5$ V		1	1.8		1	1.8	mA
I_{CCL}	$V_{CC} = 5.5$ V,	$V_I = 0$ V		1.66	3		1.66	3	mA

† All typical values are at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$

switching characteristics (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 50 Ω, T _A = MIN to MAX				UNIT
			SN54ALS15A		SN74ALS15A		
			MIN	MAX	MIN	MAX	
t _{PLH}	Any	Y	20	59	20	45	ns
t _{PHL}	Any	Y	6	25	6	20	ns

NOTE 1: Load circuit and voltage waveforms are shown in Section 1 of ALS/AS Logic Data Book, 1986.

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74ALS15AD	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74ALS15ADR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74ALS15AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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